

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT																		
NATURE OF CONVEYANCE:	ASSIGNMENT																		
CONVEYING PARTY DATA																			
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<table border="1"> <tr> <td>Name:</td> <td>Renesas Electronics Corporation</td> </tr> <tr> <td>Street Address:</td> <td>1753, Shimonumabe, Nakahara-ku,</td> </tr> <tr> <td>City:</td> <td>Kawasaki-shi, Kanagawa</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>211-8668</td> </tr> </table>		Name:	Renesas Electronics Corporation	Street Address:	1753, Shimonumabe, Nakahara-ku,	City:	Kawasaki-shi, Kanagawa	State/Country:	JAPAN	Postal Code:	211-8668								
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CORRESPONDENCE DATA																			
<p>Fax Number: 7036108686 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 7036108652 Email: sdavis@milesstockbridge.com Correspondent Name: Mitchell W. Shapiro Address Line 1: 1751 Pinnacle Drive, Suite 500 Address Line 4: McLean, VIRGINIA 22102-3833</p>																			
ATTORNEY DOCKET NUMBER:	XA-12375/T3381-19721US01																		

CH \$40.00 13990030

NAME OF SUBMITTER:	Sophia L. Davis
Signature:	/Sophia L. Davis/
Date:	08/13/2013
Total Attachments: 3 source=XA-12375-Assignment#page1.tif source=XA-12375-Assignment#page2.tif source=XA-12375-Assignment#page3.tif	

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan, located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa 211-8668, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Electronics Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Toshiaki Tsutsumi</u> (Toshiaki TSUTSUMI)	<u>17 / May / 2013</u>
2) <u>Yoshihiro Funato</u> (Yoshihiro FUNATO)	<u>17 / May / 2013</u>
3) <u>Tomonori Okudaira</u> (Tomonori OKUDAIRA)	<u>17 / May / 2013</u>
4) <u>Tadato Yamagata</u> (Tadato YAMAGATA)	<u>17 / May / 2013</u>
5) _____ (Akihisa UCHIDA)	_____
6) _____ (Takeshi TERASAKI)	_____
7) _____ (Tomohisa SUZUKI)	_____
8) _____ (Yoshiharu KANEGAE)	_____

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18/May/2013

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6) <u>Takeshi Terasaki</u> (Takeshi TERASAKI)	<u>May 21, 2013</u>
7) <u>Tomohisa Suzuki</u> (Tomohisa SUZUKI)	<u>May 21, 2013</u>
8) <u>Yoshiharu Kanegae</u> (Yoshiharu KANEGAE)	<u>May 21, 2013</u>